



NOTES:

1. INTERPRET DIMENSIONS PER ASME Y14.5M-1994.
2. THE INTERFACE OF THE HEATSINK BASE AND CPU IS FILLED WITH TPCM588 AS ALTERNATIVE PAD. THE THICKNESS OF THE PAD SHOULD BE MORE THAN 0.20 mm.
3. THE DIMENSIONS MARKED ∇ WILL BE CHECKED BY QC AND PROCESS ENGINEERS.
- ∇ \triangle MATERIAL:
 - a.HEATSINK: AL6063-T5. FINISHED: BLACK ANODIZED.
 - b,PIN: CU1100. SPRING: SWC.
5. REMOVE ALL BURRS AND EDGES WHEN FINISHED.
6. MATERIAL SHOULD BE IN ACCORDANCE WITH FOXCONN ENVIRONMENTAL SPEC. EMT-D00-079.
7. CLAMPING FORCE: 18±3 LBF
8. THE HOLE OF MB IS \varnothing 3.15MM

PHCN58GX0012	N/A
FOXCONN P/N	CUSTOMER P/N

X.±	X.'±1"	UNITS mm	NAME(INTENDED USE)	FOXCONN HON HAI PRECISION IND. CO.,LTD. TAIPEI, TAIWAN, R.O.C.
.X±0.50	.X'±0.5"	MAT'L	PART NO.(INTENDED USE)	
.XX±0.25	.XX'±	FINISH	APPD:	TITLE: CUSTOMER DRAWING
.XXX±	.XXX'±	Q'TY	CHKD:	DWG NO.:
THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF HON HAI PRECISION IND. CO., LTD. AND SHALL NOT BE REPRODUCED, COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF HON HAI PRECISION IND. CO., LTD.			DR:	SCALE 1/1 SHEET 1/1 REV. X1